

General Description

The AOTF450L is fabricated using an advanced high voltage MOSFET process that is designed to deliver high levels of performance and robustness in popular AC-DC applications. By providing low $R_{DS(on)}$, C_{iss} and C_{rss} along with guaranteed avalanche capability this part can be adopted quickly into new and existing offline power supply designs. This device is ideal for boost converters and synchronous rectifiers for consumer, telecom, industrial power supplies and LED backlighting.

For Halogen Free add "L" suffix to part number:
 AOTF450L

Product Summary

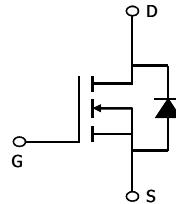
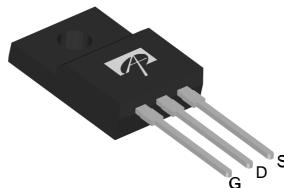
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|---------------------------------|------------|
| V_{DS} | 250V@150°C |
| I_D (at $V_{GS}=10V$) | 5.8A |
| $R_{DS(ON)}$ (at $V_{GS}=10V$) | < 0.7Ω |

100% UIS Tested
 100% R_g Tested



Top View

TO-220F



Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted

| Parameter | Symbol | Max | Units |
|--|-----------------|------------|---------------|
| Drain-Source Voltage | V_{DS} | 200 | V |
| Gate-Source Voltage | V_{GS} | ± 30 | V |
| Continuous Drain Current | I_D | 5.8* | A |
| $T_C=100^\circ C$ | I_D | 4.1* | |
| Pulsed Drain Current ^C | I_{DM} | 12 | |
| Avalanche Current ^C | I_{AR} | 1.9 | A |
| Repetitive avalanche energy ^C | E_{AR} | 54 | mJ |
| Single pulsed avalanche energy ^G | E_{AS} | 108 | mJ |
| Peak diode recovery dv/dt | dv/dt | 5 | V/ns |
| Power Dissipation ^B | P_D | 27 | W |
| Derate above $25^\circ C$ | P_D | 0.18 | W/ $^\circ C$ |
| Junction and Storage Temperature Range | T_J, T_{STG} | -55 to 175 | $^\circ C$ |
| Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds | T_L | 300 | $^\circ C$ |
| Thermal Characteristics | | | |
| Parameter | Symbol | Max | Units |
| Maximum Junction-to-Ambient ^{A,D} | $R_{\theta JA}$ | 65 | $^\circ C/W$ |
| Maximum Junction-to-Case | $R_{\theta JC}$ | 5.6 | $^\circ C/W$ |

* Drain current limited by maximum junction temperature.

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

| Symbol | Parameter | Conditions | Min | Typ | Max | Units |
|----------------------------------|---------------------------------------|--|------|------|------|-------|
| STATIC PARAMETERS | | | | | | |
| BV _{DSS} | Drain-Source Breakdown Voltage | I _D =250μA, V _{GS} =0V, T _J =25°C | 200 | | | V |
| | | I _D =250μA, V _{GS} =0V, T _J =150°C | | 250 | | |
| BV _{DSS} / ΔT_J | Zero Gate Voltage Drain Current | I _D =250μA, V _{GS} =0V | | 0.25 | | V/°C |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{DS} =200V, V _{GS} =0V | | | 1 | μA |
| | | V _{DS} =160V, T _J =125°C | | | 10 | |
| I _{GSS} | Gate-Body leakage current | V _{DS} =0V, V _{GS} =±30V | | | ±100 | nA |
| V _{GS(th)} | Gate Threshold Voltage | V _{DS} =5V, I _D =250μA | 3.6 | 4.2 | 4.5 | V |
| R _{DS(ON)} | Static Drain-Source On-Resistance | V _{GS} =10V, I _D =2.9A | | 0.57 | 0.7 | Ω |
| g _{FS} | Forward Transconductance | V _{DS} =40V, I _D =2.9A | | 3.4 | | S |
| V _{SD} | Diode Forward Voltage | I _S =1A, V _{GS} =0V | | 0.78 | 1 | V |
| I _S | Maximum Body-Diode Continuous Current | | | | 5.8 | A |
| I _{SM} | Maximum Body-Diode Pulsed Current | | | | 12 | A |
| DYNAMIC PARAMETERS | | | | | | |
| C _{iss} | Input Capacitance | V _{GS} =0V, V _{DS} =25V, f=1MHz | 150 | 194 | 235 | pF |
| C _{oss} | Output Capacitance | | 25 | 40 | 55 | pF |
| C _{rss} | Reverse Transfer Capacitance | | | 3.3 | | pF |
| R _g | Gate resistance | V _{GS} =0V, V _{DS} =0V, f=1MHz | 1.8 | 3.6 | 5.4 | Ω |
| SWITCHING PARAMETERS | | | | | | |
| Q _g | Total Gate Charge | V _{GS} =10V, V _{DS} =160V, I _D =5.8A | 2.8 | 3.6 | 4.4 | nC |
| Q _{gs} | Gate Source Charge | | | 1.7 | | nC |
| Q _{gd} | Gate Drain Charge | | | 0.6 | | nC |
| t _{D(on)} | Turn-On DelayTime | | | 11 | | ns |
| t _r | Turn-On Rise Time | V _{GS} =10V, V _{DS} =100V, I _D =5.8A, R _G =25Ω | | 20 | | ns |
| t _{D(off)} | Turn-Off DelayTime | | | 13 | | ns |
| t _f | Turn-Off Fall Time | | | 8 | | ns |
| t _{rr} | Body Diode Reverse Recovery Time | I _F =5.8A, dI/dt=100A/μs, V _{DS} =100V | 95 | 121 | 150 | ns |
| Q _{rr} | Body Diode Reverse Recovery Charge | I _F =5.8A, dI/dt=100A/μs, V _{DS} =100V | 0.40 | 0.51 | 0.62 | μC |

A. The value of R_{WA} is measured with the device in a still air environment with T_A=25°C.

B. The power dissipation P_D is based on T_{J(MAX)}=175°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=175°C. Ratings are based on low frequency and duty cycles to keep initial T_J=25°C.

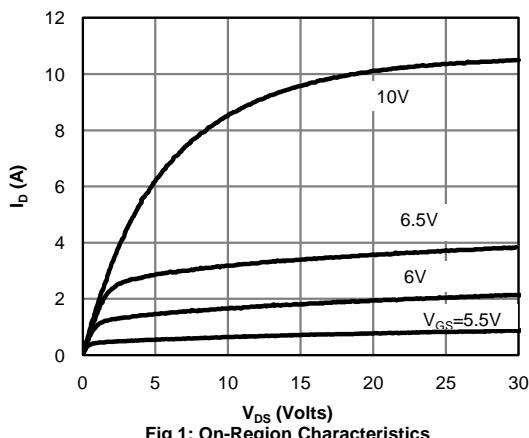
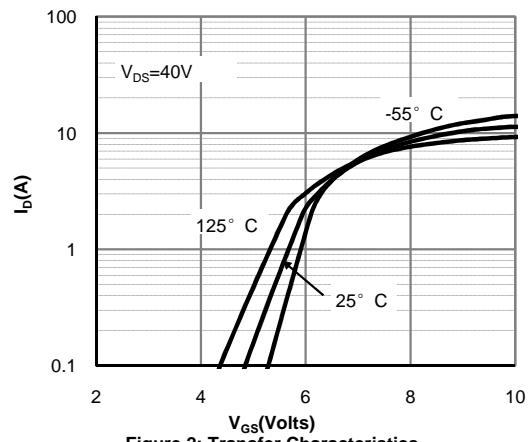
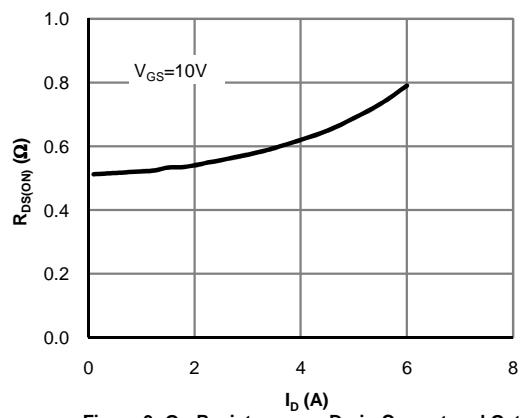
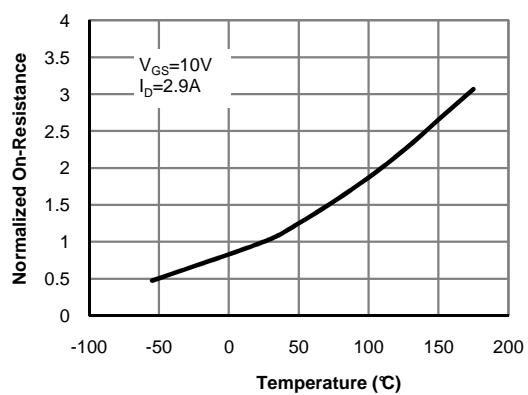
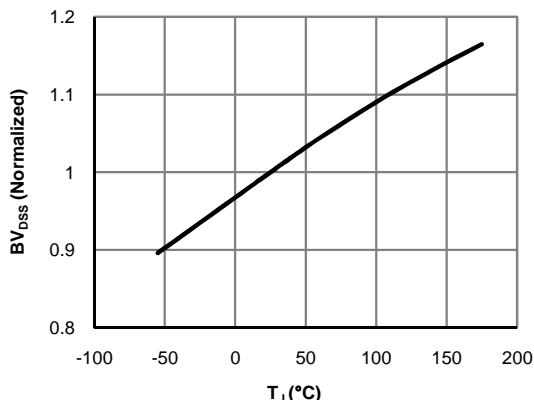
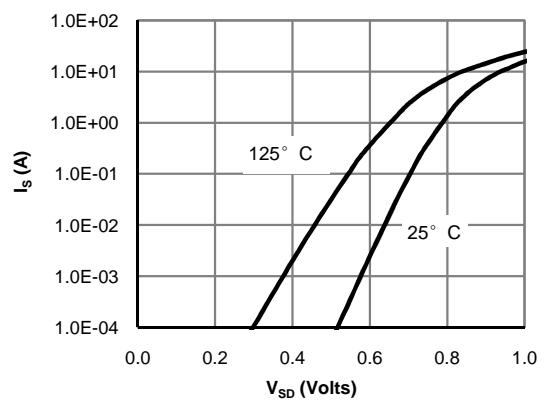
D. The R_{WA} is the sum of the thermal impedance from junction to case R_{WC} and case to ambient.

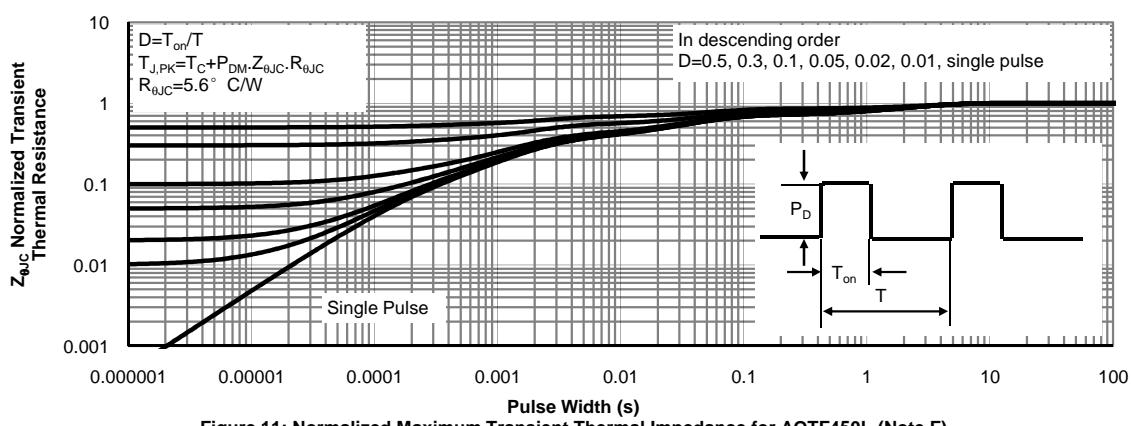
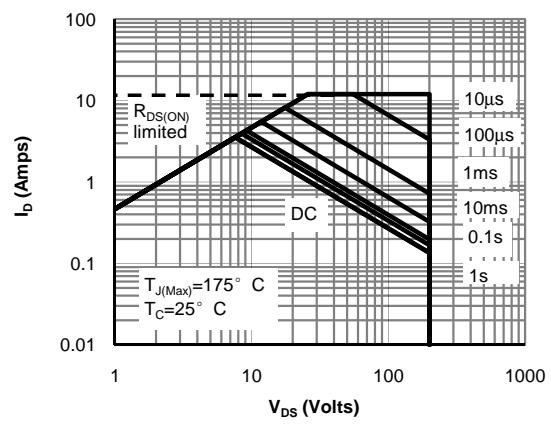
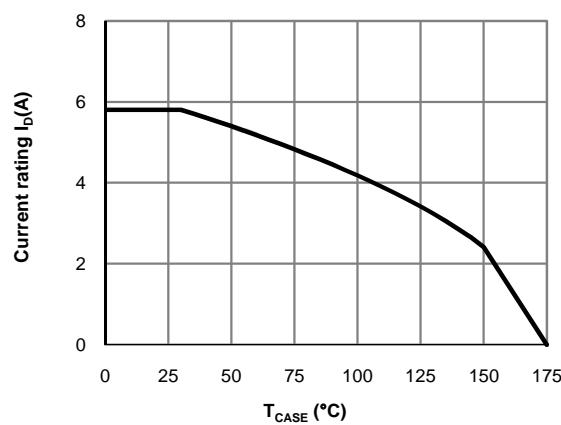
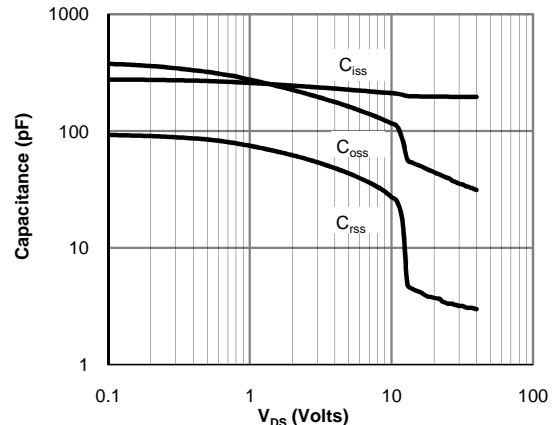
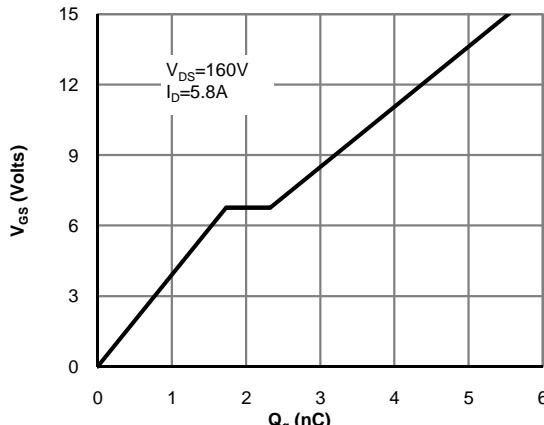
E. The static characteristics in Figures 1 to 6 are obtained using <300 μs pulses, duty cycle 0.5% max.

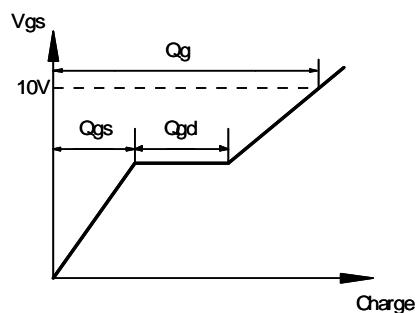
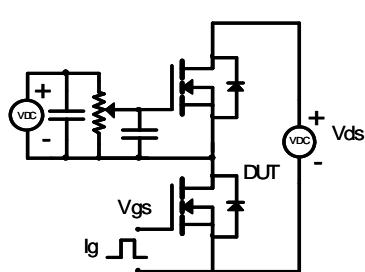
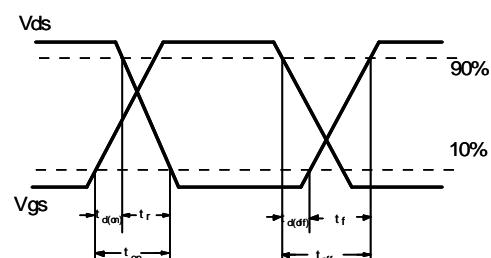
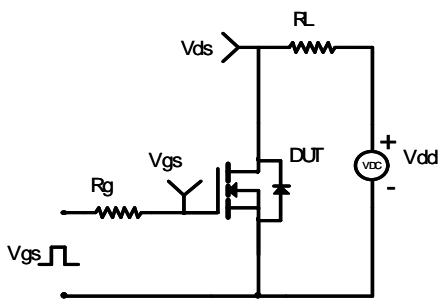
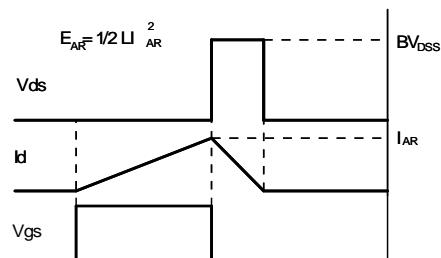
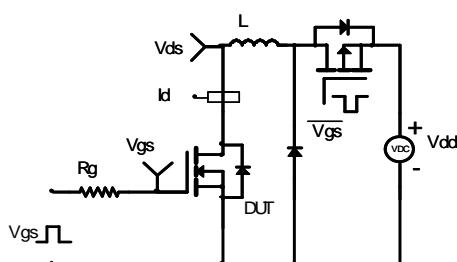
F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of T_{J(MAX)}=175°C. The SOA curve provides a single pulse rating.

G. L=60mH, I_{AS}=1.9A, V_{DD}=150V, R_G=25Ω, Starting T_J=25°C

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

Fig 1: On-Region Characteristics

Figure 2: Transfer Characteristics

Figure 3: On-Resistance vs. Drain Current and Gate Voltage

Figure 4: On-Resistance vs. Junction Temperature

Figure 5: Break Down vs. Junction Temperature

Figure 6: Body-Diode Characteristics (Note E)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS


Gate Charge Test Circuit & Waveform

Resistive Switching Test Circuit & Waveforms

Unclamped Inductive Switching (UIS) Test Circuit & Waveforms

Diode Recovery Test Circuit & Waveforms
